

# NS350 v33 Trusted Cryptography Module 2.0 Data brief Revision 1.00

### **Key Features**

- Compliant to GM/T 0012-2020 Trusted computing Trusted computing interface specification of trusted cryptography module
- I2C Interface, fast mode (400kbs)
- Enhanced (-40~+85°C)
- QFN16 and QFN32 package
- 1.8 V or 3.3 V supply voltage range
- Active shield and environmental sensors
- Monitoring of environmental parameters (power, temperature)
- Hardware and software protection against fault injection
- Random Number Generator (RNG) implemented according the requirements of GM/T 0062
- 24 PCRs (SM3)
- SM2, SM3, SM4
- Full personalization Endorsement Key (EK) certificates
- Field Upgrade allows secure firmware updates



# **Revision History**

Revision Date	Revision	Description
2024-03-29	1.00	First released



## **Table of Contents**

Table c	of Contents			
1 Sco	ope	4		
1.1	Device Information	4		
1.2	Scope and purpose	4		
2 Pin Description				
3 Typical Schematic				
4 Pao	ckage Information			
4.1	Package Dimensions	8		
4.2	.2 Packing Type			
4.3	Recommended footprint	11		
4.4	Chip Marking	12		
IMPOR	IMPORTANT NOTICE			



## 1 Scope

### **1.1 Device Information**

The NS350 v33 is a cost-effective and high-performance Trusted Cryptography Module 2.0 (TCM 2.0) targeting PCs, server platforms and embedded systems. It is available in QFN32 package.

### Table 1 Part Number

Part Number	Firmware Version	Description
NS350-KQBR-x10	33.05	Enhanced temperature range (-40~+85°C)
		TCM 2.0 profile, I2C interface, QFN32-package,
		Tape & Reel delivery

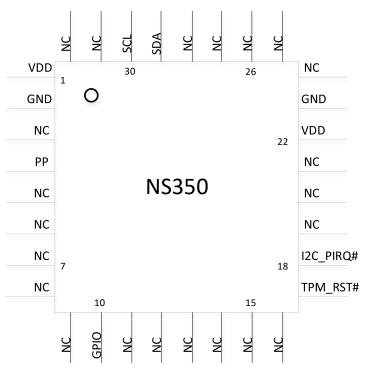
Note: x as customer-specific letter: A, D, G, H, I, J, L, M, N, R, S, V, or T

### **1.2 Scope and purpose**

This document describes the NS350 v33 TCM2.0 together with its features and functionality. It is primarily intended for system developers.



# 2 Pin Description





### Table 2 I/O Signals

Pin Name	Pin Number	Туре	Description	
VDD	1, 22	I	Power Supply All VDD pins must be connected	
			externally and should be bypassed to GND via 100 nF	
			capacitors. This is a 3.3 volt or 1.8V DC power rail	
			supplied by the motherboard to the module	
GND	2, 23	I	Ground All GND pins must be connected externally.	
			Zero volts. Expected to be connected to main	
			motherboard ground	
TPM_RST#	17	Ι	TPM_RST#: Active Low, internal weak pull up	
I2C_PIRQ#	18	0	I2C_PIRQ#: Optional location for I2C PIRQ#, active	
			low, open drain.	
SDA	29	I/O	I2C Data pin	
SCL	30	0	I2C Clock pin	
NC	3,5,6,7,8,9,		No Connected (can be connected externally)	



	11,12,13,14, 15,16,19,20, 21,24,25,26, 27,28,31,32		
PP	4	I	This pin may be left unconnected;
			Physical Presence, active high, internal pull-down.
			Used to indicate Physical Presence to the function
GPIO	10	I/O	This pin may be left unconnected;
			Input by default, internal pull up;
			It can be controlled via trusted GPIO functionality

Notes:

- 1. I input only, O output only
- 2. All pins must have the power at the same time in the whole life time when be used, include all VDD pins and IO pins



# **3** Typical Schematic

Figure 2 shows the typical schematic for the NS350 v33. The power supply pins should be bypassed to GND with capacitors located close to the device.

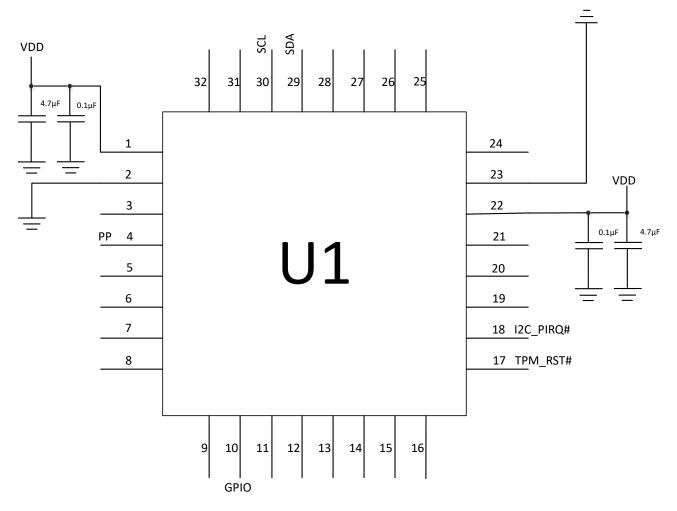


Figure 2 Typical Schematic



# 4 Package Information

## 4.1 Package Dimensions

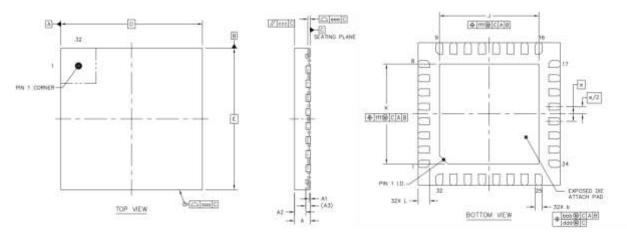


Figure 3 Package Symbol

### **Table 3 Symbol and Dimension**

Server and the server	-	SYMBOL	MIN	NOM	MAX
TOTAL THICKNESS		A	0.5	0.55	0.6
STAND OFF		A1	0	0.035	0.05
MOLD THICKNESS		A2		0.4	
L/F THICKNESS		A3	0.152 R		REF
LEAD WIDTH		b	0.2	0.25	0.3
BODY SIZE	x	D	5		BSC
	Y.	E	5 B		BSC
LEAD PITCH		e	0.5		BSC
EP SIZE	X	J	3.4	3.5	3.6
	Y	ĸ	3.4	3,5	3,6
LEAD LENGTH		L	0.3	0.4	0.5
PACKAGE EDGE TOLERANCE		000	0.1		
ICAR OFFICET		bbb	0.1		
LEAD OFFSET		ddd	0.05		
MOLD FLATNESS		ecc	0.1		
COPLANARITY		eee	0.08		
EXPOSED PAD OFFSET		fff.	0.1		
				2	

NOTES:

- 1. Coplanarity applies to leads, corner leads and die attach pad.
- 2. Total thickness not include SAW BURR.



4.2 Packing Type

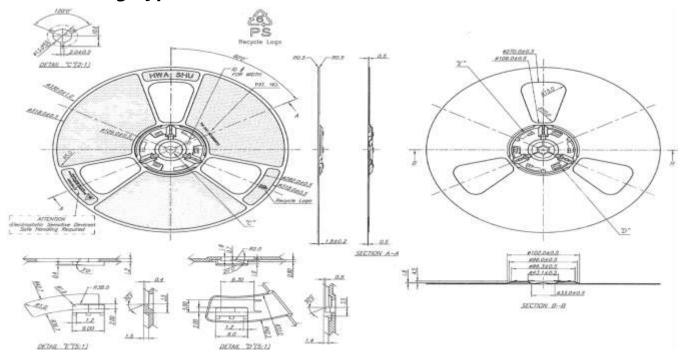


Figure 4 Reel diagram

Tape & Reel (reel diameter 330mm), 3000 pcs. per reel.



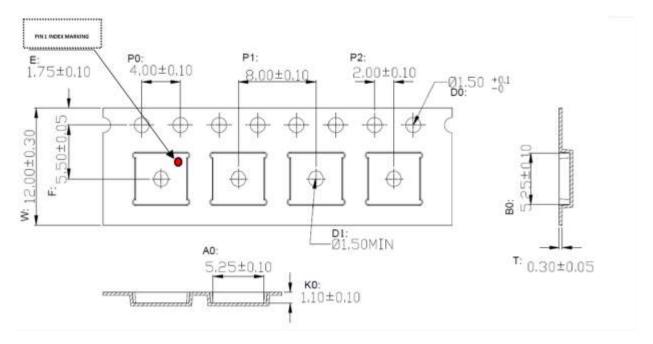


Figure 5 Packing Type



### 4.3 Recommended footprint

Figure shows the recommended footprint for the package.

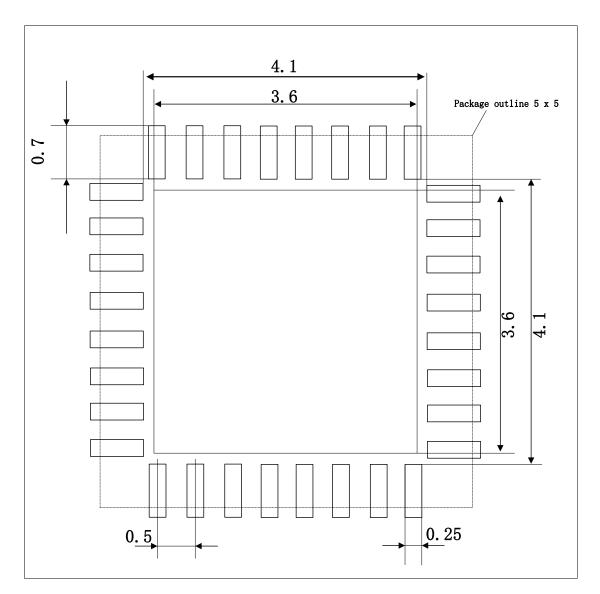


Figure 6 Recommended Footprint



### 4.4 Chip Marking



Figure 7 chip Marking

Description

### (1) Line 1 - Hardware Technology name

NS350 is the name of the hardware technology.

#### (2) Line 2 - Device model

WW=BI means support temperature from -40°C to 85°C, I2C interface.

YY is the symbol for firmware version.

#### Table 4 symbol and firmware version

Symbol	Firmware version
YY = 03	33.05

#### (3) Line 3 - Device information

XXXXXXXX is production lot number.

XX(Reserved)+X[Year]+XX[Week]+XXX[Wafer Lot Number. 000~999].

#### (4) #1 Pin Position Mark

" $\circ$ " indicates the position of #1 pin.



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